

AMPMODU | AMPMODU 50/50 Grid

TE Internal #: 104786-6

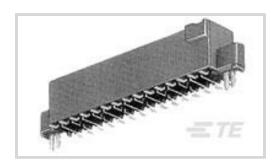
AMPMODU 50/50 Grid, PCB Mount Receptacle, Vertical, Board-to-Board, 60 Position, 1.27mm [.05in] Centerline, Gold, Printed Circuit

Board

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Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 60

Centerline (Pitch): 1.27 mm [.05 in]

Features

Product Type Features

Product Type reatures	
PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Rows	2
PCB Mount Orientation	Vertical
Number of Positions	60
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Operating Voltage	30 VAC
Body Features	
PCB Retention Feature Material	Copper Alloy
PCB Retention Feature Plating Material	Tin-Lead over Nickel

.5 mm[.02 in]

Copper Alloy

150 μin

Tin-Lead

Contact Features

Mating Square Post Dimension

Contact Base Material

PCB Contact Termination Area Plating Material



Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Socket
Contact Current Rating (Max)	.5 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.08 mm[.003 in]
Rectangular Termination Post & Tail Width	.36 mm[.014 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
PCB Mount Retention Type	Hold-Down Post
Mating Alignment	With
Mating Alignment Type	Polarizing Tab
PCB Mount Retention	With
PCB Mount Alignment	Without
Housing Features	
Centerline (Pitch)	1.27 mm[.05 in]
Housing Color	Black
Housing Material	LCP - GF (Liquid Crystal Polymer)
Dimensions	
Connector Height	4.75 mm[.187 in]
Row-to-Row Spacing	1.27 mm[.05 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-53.8 – 157 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	12
Packaging Method	Box & Tube, Tube



Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUN 2020 (209) Candidate List Declared Against: JUN 2020 (209) Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | AMPMODU 50/50 Grid





Board-to-Board Headers & Receptacles(283)



PCB Connector Covers(9)



Ribbon Cable Connectors(32)

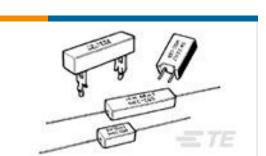


Wire-to-Board Headers & Receptacles (12)

Customers Also Bought



TE Model / Part #5-1423901-9 W54-XB2A4A10-10=CKTBKR,THERM, PB,QC.250



TE Model / Part #1-1623793-9 SQP5 3R9 5% Wire



TE Model / Part #1-282841-1 TERMI-BLOK PCB MOUNT 11P.5



TE Model / Part #2-2329328-0
PB OFF/ON HC BLU M4 TERM. IP68



TE Model / Part #1625888-2 2W STD M/OX 5% 180R



TE Model / Part #1-2176322-2 SMV 1W 820K 5%



TE Model / Part #3-644488-3 13P MTA100 SHRD HDR F/L R/A SN



TE Model / Part #3-794616-0 10P MICRO MNL PLUG HSG FREE HNG DBL RW



Documents

Product Drawings
60 50/50 GRID DRST SFMNT RCPT

English

Product Specifications

Application Specification

English

Product Environmental Compliance

AMPMODU 50/50 Grid, PCB Mount Receptacle, Vertical, Board-to-Board, 60 Position, 1.27mm [.05in] Centerline, Gold, Printed Circuit Board



TE Material Declaration

English